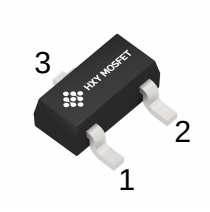
HESDNC24VB2I-A
ESD PROTECTION DIODE

Discription

The HESDNC24VB2I-A protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

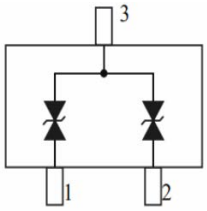
It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.



SOT-23

Features

★ Low Leakage
★ IEC61000−4−2 Level 4 ESD Protection
★ We declare that the material of product compliant with RoHS requirements and Halogen Free.
★ S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.



Circuit Diagram

Ordering Information

Product ID	Pack	Qty(PCS)
HESDNC24VB2I-A	SOT-23	3000

Absolute Ratings (T_{amb}=25°C)

Symbol	Parameter	Value	Units
P_{PP}	Peak Pulse Power (t_p = 8/20μs)	160	W
T_L	Maximum lead temperature for soldering during 10s	260	°C
T_{stg}	Storage Temperature Range	-55 to +150	°C
T_{op}	Operating Temperature Range	-55 to +125	°C
T_j	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD) air discharge contact discharge	±30 ±30	KV

ELECTRICAL CHARACTERISTICS

Device	V_{RWM} (V)	I_R (μA) @ V_{RWM}	V_{BR} (V) @ I_T (Note 1)		I_T	V_C (V) @MAX I_{PP} (Note 2)	I_{PP}(A) (Note 2)	P_{PK}(W) (Note 2)	C (pF)
	Max	Max	Min	Max	mA	Max	Max	Max	Typ
HESDNC24VB2I-A	24	0.5	26	33	1	40	4	160	10

Other voltage available upon request.

1. V_{BR} is measured with a pulse test current ITat an ambient temperature of 25℃
2. Surge current waveform per Figure 1.

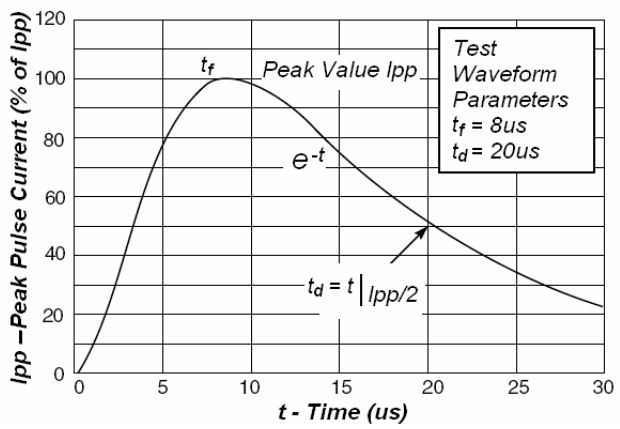


Fig1. Pulse Waveform

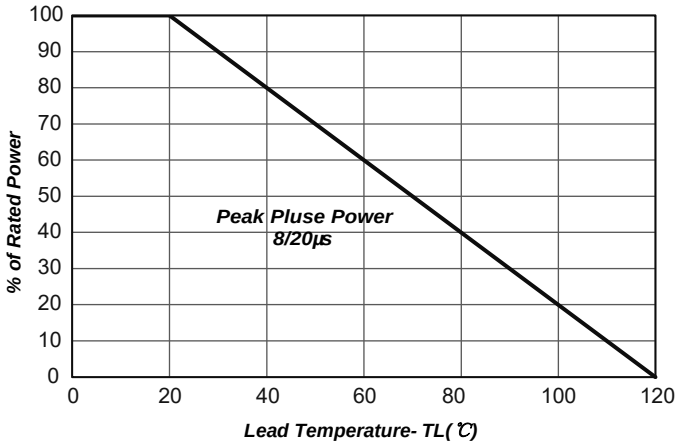
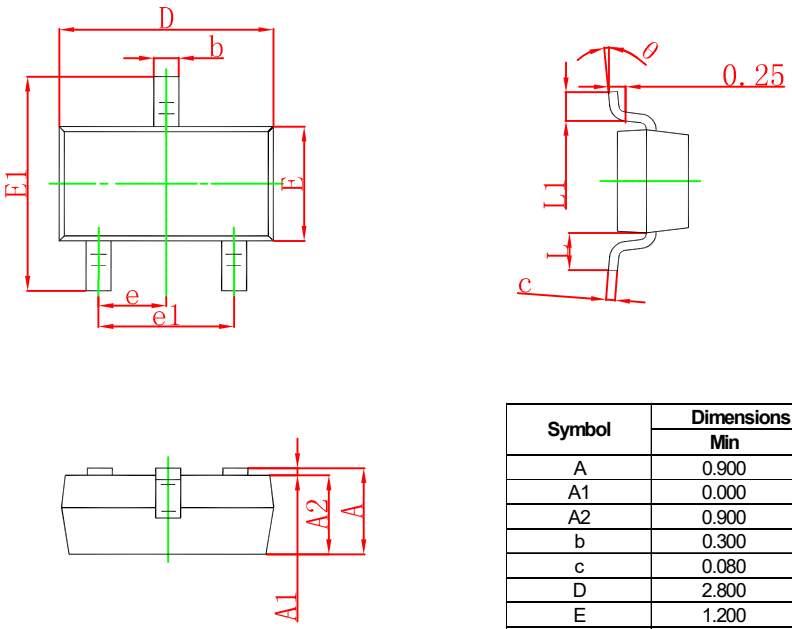


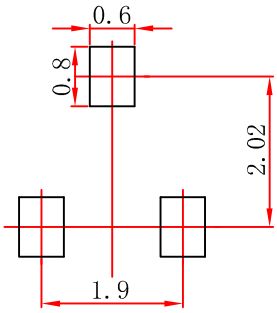
Fig2.Power Derating Curve

SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:
1.Controlling dimension:in millimeters.
2.General tolerance:± 0.05mm.
3.The pad layout is for reference purposes only.

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